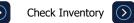
ASDTDV







2.5 x 2.0 x 1.0mm **RoHS/RoHS II Compliant** MSL Level = 1



Features

- Continuous Vdd operation from $1.68 \text{ V} \sim 3.63 \text{ V}$
- Low current consumption
- Standby (Power Down) function
- Output waveform CMOS
- Hermetically seam-sealed ceramic package

Applications

- Portable & wearable electronics
- Internet of Things (IoT)
- Consumer electronics
- Industrial control & automation
- Mobile communication

Electrical Specifications

| Parameters | | Min. | Typ. | Max. | Units | Notes |
|--|-------------------------|--|------|---------|-------|-------------|
| Frequency Range | | 9.6 | | 60 | MHz | |
| Operating Temperature Range | | -40 | | +125 | °C | See options |
| Storage Temperature Range | | -55 | | +125 | °C | |
| Overall Frequency Stability [Note 1] | | -10 | | +10 | ppm | See options |
| Supply Voltage (Vdd) | | 1.68 | | 3.63 | V | |
| Output Load | Output Load | | | 15 | рF | CMOS |
| Output Voltage | Voh | 0.9*Vdd | | | V | |
| Output Voltage | V_{OL} | | | 0.1*Vdd |] | |
| Aging 1 year @25°C± 3°C | | -1.0 | | +1.0 | ppm | |
| Symmetry @ ½ Vdd | | 45 | 50 | 55 | % | |
| Start-up Time | | | | 10.0 | ms | |
| Rise and Fall Time (Tr/Tf) @10%Vdd-90%Vdd, 15pF load | Vdd = 1.8V to 3.63V | | | 5.0 | | |
| | Vdd = 1.68V to 1.79V | | | 8.0 | ns | |
| RMS Phase Jitter @25°C± 3°C (10 - 39MHz: 12kHz to 5MHz) (>39MHz: 12kHz to 20MHz) | | | | 1.0 | ps | |
| Tri-state function | | "1" (VIH≥0.7*Vdd) or Open: Oscillation; "0" (VIL<0.3*Vdd): No Oscillation/Hi Z | | | V | |
| Disable Current | | | | 10.0 | μA | |

Note 1:

Overall frequency stability includes initial frequency tolerance @25°C± 3°C and stability over the operating temperature range.

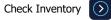


ASDTDV





ESD Sensitive (Pb)



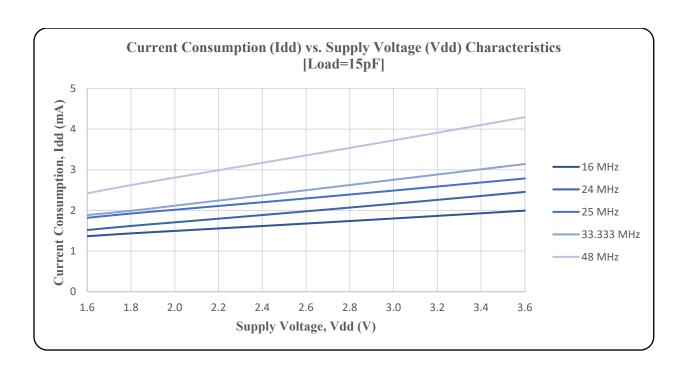


2.5 x 2.0 x 1.0mm **RoHS/RoHS II Compliant** MSL Level = 1

Electrical Specifications *continued*

| Parameters | Min. | Typ. | Max. | Units | Notes |
|--|------|------|------|-------|----------------------|
| Supply Current (Idd) into 15pF Load @25°C± 3°C @ Vdd=3.3V | | | 4.8 | | 9.60MHz to 20.00MHz |
| | | | 5.5 | | 20.01MHz to 30.00MHz |
| | | | 6.0 | mA | 30.01MHz to 40.00MHz |
| | | | 7.0 | | 40.01MHz to 50.00MHz |
| | | | 8.0 | | 50.01MHz to 60.00MHz |
| Supply Current (Idd) into 15pF Load @25°C± 3°C @ Vdd=2.5V | | | 4.3 | | 9.60MHz to 20.00MHz |
| | | | 5.0 | mA | 20.01MHz to 30.00MHz |
| | | | 5.5 | | 30.01MHz to 40.00MHz |
| | | | 6.5 | | 40.01MHz to 50.00MHz |
| | | | 7.5 | | 50.01MHz to 60.00MHz |
| Supply Current (Idd) into 15pF Load @25°C± 3°C @ Vdd=1.8V | | | 3.8 | | 9.60MHz to 20.00MHz |
| | | | 4.5 | | 20.01MHz to 30.00MHz |
| | | | 5.0 | mA | 30.01MHz to 40.00MHz |
| | | | 6.0 | | 40.01MHz to 50.00MHz |
| | | | 7.0 | | 50.01MHz to 60.00MHz |

Typical Current Consumption (Idd) vs. Supply Voltage (Vdd) Characteristics @25C°C±3°C [Load=15pF]





ASDTDV

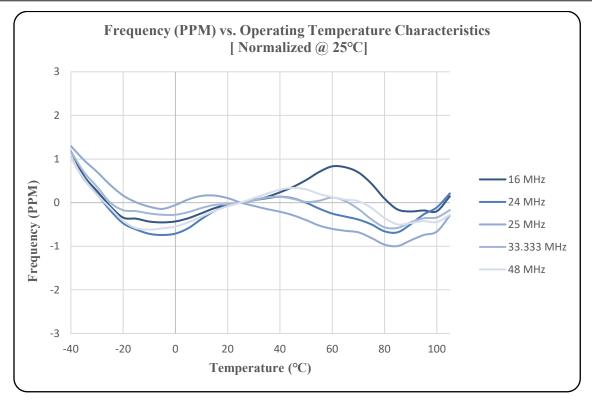


Check Inventory (>)

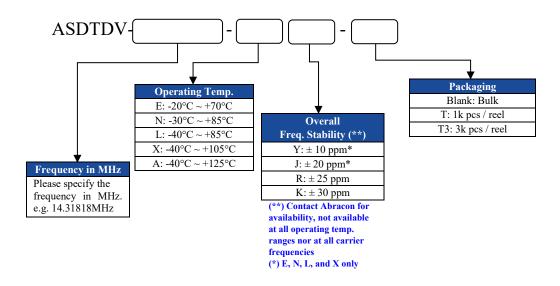


2.5 x 2.0 x 1.0mm **RoHS/RoHS II Compliant** MSL Level = 1

Typical Frequency vs. Operating Temperature Characteristics @ Vdd = 2.5V [Load=15 pF]



Part Identification





ASDTDV

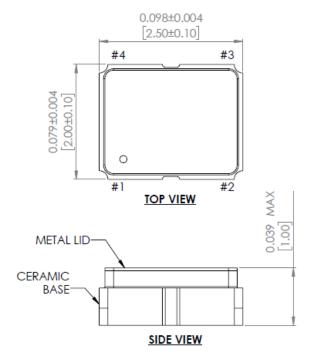


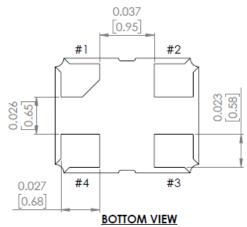
Check Inventory (>)

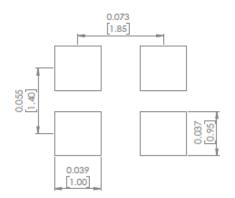


2.5 x 2.0 x 1.0mm RoHS/RoHS II Compliant MSL Level = 1

Mechanical Dimensions







| Pin # | Function |
|-------|-----------|
| 1 | Tri-State |
| 2 | GND |
| 3 | Output |
| 4 | Vdd |

Note: Recommended to use approximately $0.01 \mu F$ bypass capacitor between PIN 2 and PIN 4

| INH Function | | | | |
|--------------|-------------------------|--|--|--|
| PAD #1 | PAD #3 (Output) | | | |
| Open | Active | | | |
| "H" Level | Active | | | |
| "L" Level | High Z (No Oscillation) | | | |

Dimensions: inches (mm)



ASDTDV





ESD Sensitive (Pb)



2.5 x 2.0 x 1.0mm **RoHS/RoHS II Compliant** MSL Level = 1

Reflow Profile [JEDEC J-STD-020]

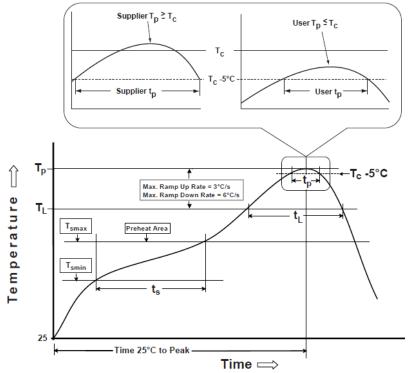


Table 1 **SnPb Eutectic Process** Classification Temperatures (Tc) Package Volume mm³ Volume mm³ Thickness <350 <u>></u>350 235 °C 220 °C <2.5 mm ≥2.5 mm 220 °C 220 °C

| Table 2 | | | | | |
|---|--------------------|------------------------------------|---------------------|--|--|
| Pb-Free Process | | | | | |
| Classification Temperatures (T _c) | | | | | |
| Package Thickness | Volume mm³ <350 | Volume mm ³ 350-2000 | Volume mm³ >2000 | | |
| <1.6 mm | 260 °C | 260 °C | 260 °C | | |
| 1.6 mm - 2.5 mm | 260 °C | 250 °C | 245 °C | | |
| >2.5 mm | 250 °C | 245 °C | 245 °C | | |

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|-------------------------|---------------------|
| Preheat / soak | | |
| Temperature minimum (T _{smin}) | 100°C | 150°C |
| Temperature maximum (T _{smax}) | 150°C | 200°C |
| Time (T _{smin} to T _{smax}) (t _s) | 60 - 120 sec. | 60 - 120 sec. |
| Average ramp-up rate (T _{smax} to T _P) | 3°C/sec. max | 3°C/sec. max |
| Liquidous temperature (T _L) | 183°C | 217°C |
| Time at liquidous (t _L) | 60 - 150 sec. | 60 - 150 sec. |
| Peak package body temperature (T _P)* | see Table 1 | see Table 2 |
| Time $(t_p)^{**}$ within 5°C of the specified classification temperature (T_c) | 20 sec. | 30 sec. |
| Ramp-down rate (T _p to T _{smax}) | 6°C/sec. max | 6°C/sec. max |
| Time 25°C to peak temperature | 6 min. max | 8 min. max |
| Reflow cycles | 2 max | 2 max |

^{*}Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.



^{**}Tolerance for time at peak profile temperature (tp) is defined as supplier minimum and a user maximum.

ASDTDV

Request Samples (>)



ESD Sensitive (Pb)

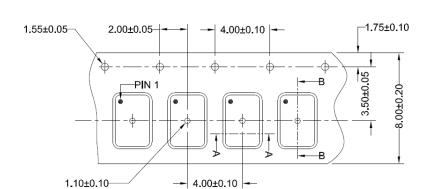
Check Inventory (>)

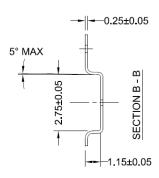


2.5 x 2.0 x 1.0mm **RoHS/RoHS II Compliant** MSL Level = 1

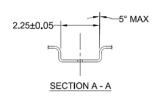
Packaging

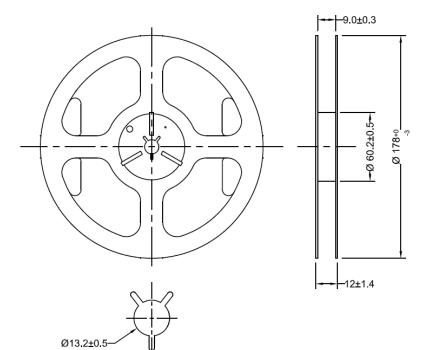
T: 1,000pcs/reel T3: 3,000pcs/reel





FEEDING (PULL) DIRECTION





Dimensions: mm

ATTENTION: Abracon LLC's products are COTS - Commercial-Off-The-Shelf products; suitable for Commercial, Industrial and, where designated, Automotive Applications. Abracon's products are not specifically designed for Military, Aviation, Aerospace, Life-dependent Medical applications or any application requiring high reliability where component failure could result in loss of life and/or property. For applications requiring high reliability and/or presenting an extreme operating environment, written consent, and authorization from Abracon LLC is required. Please contact Abracon LLC for more information.

